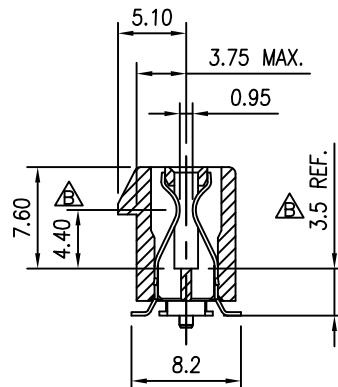
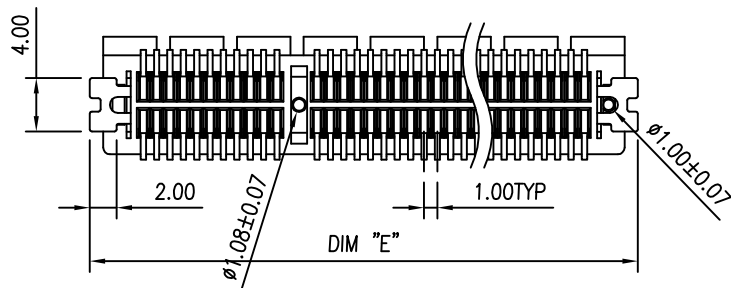
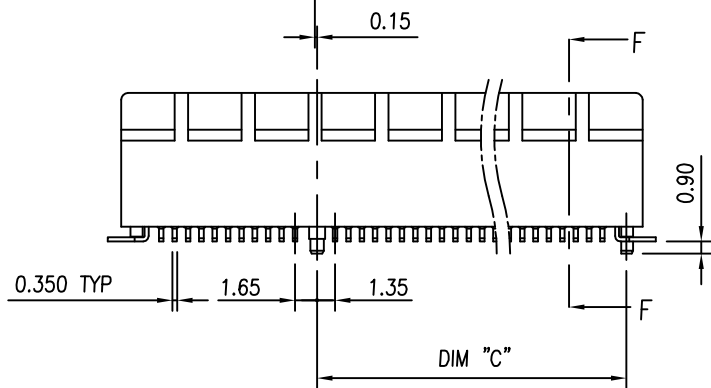
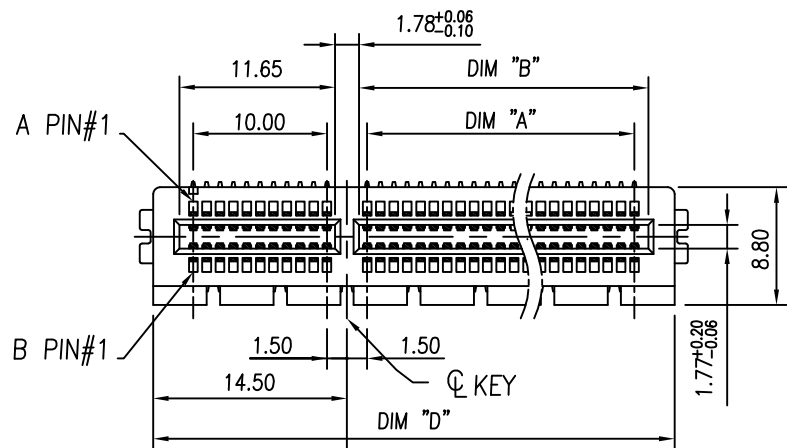
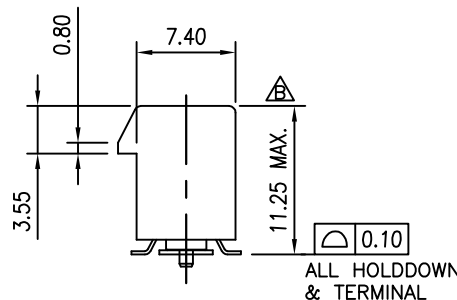




SECTION F-F



DIMENSIONS					
POSITION	A ±0.20	B ± 0.20 -0.08	C ±0.25	D ±0.25	E ±0.25
36	6	7.65	9.15	25.00	27.00
64	20	21.65	23.15	39.00	41.00
98	37	38.65	40.15	56.00	58.00
164	70	71.65	73.15	89.00	91.00

NOTES:

1. MATERIAL:

1.1 HOUSING: THERMOPLASTIC, HIGH TEMP, UL94V-0, COLOR: BLACK.

1.2 CONTACTS: COPPER ALLOY.

1.3 HOLDDOWN: COPPER ALLOY.

2. FINISH:

2.1 CONTACT:

SELECTIVE GOLD PLATING ON CONTACT AREA.

100μ" MIN. MATTE TIN PLATING ON SOLDER TAILS,

50μ" MIN. NICKEL UNDERPLATING OVERALL.

2.2 HOLDDOWN:

100μ" MIN. MATTE TIN PLATING WITH 50μ" MIN. NICKEL UNDERPLATE OVERALL.

PART NO.

3113 - 1 X X X
PCI EXPRESS Series No.
HSG Color
1: Black
Contact Plating
0: 30μ", Gold
1: 15μ", Gold
2: 1μ", Gold
POS. Options
0: 36 Pin
1: 64 Pin
2: 98 Pin
3: 164 Pin

Packing Options
T: Tray Without Cap
C: Tray With Cap
N: Tray With Mylar
R: Tape & Reel Packaging Without Cap
(For 36 & 64P)
P: Tape & Reel Packaging With Cap
(For 36 & 64P)
M: Tape & Reel Packaging With Mylar
(For 36 & 64P)

				TOLERANCE		UMax conn 东莞市友贸实业有限公司 DONGGUAN UMAXCONN ENTERPRISE LIMITED	
				LINEAR	ANGLES		
				X.±0.40	X'.±		
B	11059	Terry	Oct,06,2011	.X±0.30	.X'±	APPD: Jason	MAT'L:
A	09038	Terry	Aug,13,2009	.XX±0.20	.XX'±	CHKD: Schumi	FINISH:
REV	ECN NO.	NAME	DATE	.XXX±0.10	.XXX'±	DRWN: Terry	Q'TY:

UNITS	SCALE	SHEET	REV
MM	1 : 1	1 OF 2	B

